IPC ASSOCIATION ELECTRONICS	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved unde international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowe level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute								terials and l	Mfg Inform	nation			
Supplier	Information														
Company name*			Company unique ID			ı	Unique ID Authority				Respo	Response Date*			
nsemi											2024-0	2024-05-18			
Contact Na	ame		Title - Contact]	Phone - Contact*				Email	Email - Contact*			
Product-E	Inv-Stewards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
uthorized	l Representative*		Title - Representative]	Phone - Representative*				Email	Email - Representative*			
Product-E	inv-Stewards		Product Enviro Compliance				NA				Produ	Product-Env-Stewards@onsemi.com			
	Requester Item Number Mfr Item		n Number Mfr Item Name				Effective Dat	ate Version Manufacturing Site			Weight*	UOM	Unit Type		
		NRVUA140VT3G- GA01 REC SMA 1A 400		V ULTFST T	TR .	2024-05-18 CNP		CNP		62.01	mg	Each			
Manufac	cturing Proccess Information	ation													
,	Terminal Plating / Grid Array Material Terminal Base Allo			Alloy J-	J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Pe					ak Temper	ature Nu	mber of Reflow Cy	cles		
Matte Tin (Sn) - annealed CU Alloy			1			260		C	30	seco	onds 3				
Comments															
evel 1 - ma	aximum time at peak temperat	ture during sol	dering is 10-3	30 seconds											
or more i	nformation regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).										
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and cornect to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.										
RoHS Declaration * 4 - Item(s	s) does not contain RoHS restricted substance	ces per the definition above except for selected exer	nptions Supplier Acceptance	* Accepted						
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). Exemption: 7c-I Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature R		,								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Clip	6.0	mg	Supplier	Iron (Fe)	7439-89-6		0.006	mg
			Supplier	Copper (Cu)	7440-50-8		5.9922	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0018	mg
Die	0.84	mg	Supplier	Silicon (Si)	7440-21-3		0.785	mg
			В	Nickel (Ni)	7440-02-0		0.0097	mg
			Supplier	Lead Bisilicate	65997-18-4	7c	0.0454	mg
Die Attach Solder	2.92	mg	Supplier	Silver (Ag)	7440-22-4		0.073	mg
			A	Lead (Pb)	7439-92-1	7a	2.701	mg
			Supplier	Tin (Sn)	7440-31-5		0.146	mg
Lead Frame	22.63	mg	Supplier	Iron (Fe)	7439-89-6		0.0226	mg
			Supplier	Copper (Cu)	7440-50-8		22.6006	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0068	mg
Mold Compound-Black	29.54		Supplier	Polycondensate of 4,4'-bis(methoxymethyl)biphenyl and phenol	205830-20-2		0.7385	mg
			Supplier	Triphenylphosphine	603-35-0		0.1477	mg
			Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.1477	mg
			Supplier	4,4'-Bis(2,3-epoxypropoxy)-3,3',5,5'-tetramethylbiphenyl	85954-11-6		0.1477	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2954	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		26.586	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.477	mg
Plating	0.08	mg	Supplier	Tin (Sn)	7440-31-5		0.08	mg